

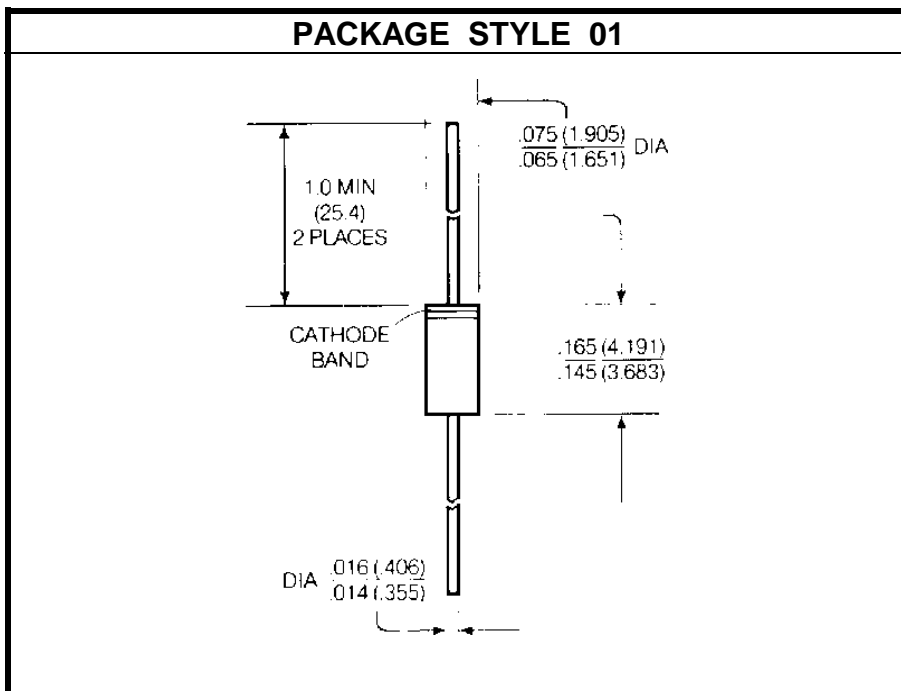
# SILICON PIN DIODE CHIP

## DESCRIPTION:

The **AP300A-00** is a Passivated Epitaxial Silicon PIN Diode Housed in a Hermetically Sealed Glass Package. This Device is Designed to Cover a Wide Range of Control Applications Such as RF Switching, Phase Shifting, Modulation, Duplexing Limiting and Pulse Forming.

## MAXIMUM RATINGS

<b>I<sub>F</sub></b>	100 mA
<b>V<sub>R</sub></b>	300 V
<b>P<sub>DISS</sub></b>	250 mW @ T <sub>A</sub> = 25 °C



## CHARACTERISTICS T<sub>C</sub> = 25 °C

SYMBOL	TEST CONDITIONS	MINIMUM	TYPICAL	MAXIMUM	UNITS
<b>V<sub>BR</sub></b>	I <sub>R</sub> = 10 μA	300			<b>V</b>
<b>C<sub>J</sub></b>	V <sub>R</sub> = 50 V V <sub>R</sub> = 40 V			0.2	<b>pF</b>
<b>R<sub>S</sub></b>	I <sub>F</sub> = 50 mA f = 100 MHz			0.6	<b>Ohms</b>
<b>T<sub>L</sub></b>	I <sub>F</sub> = 10 mA I <sub>R</sub> = 6.0 mA		1000		<b>nS</b>
<b>T<sub>rr</sub></b>	I <sub>F</sub> = 20 mA I <sub>R</sub> = 100 mA		100		<b>nS</b>
<b>O<sub>R</sub></b>	THERMAL RESISTANCE			20	<b>°C/W</b>